TE Internal #: 4-2337939-8

Board-to-Board, 164 Position, 1 mm [.039 in] Centerline, Vertical,

Black, Signal, -40 – 85 °C [-40 – 185 °F], PCI & PCI Express

Connectors

View on TE.com >



Connectors > PCB Connectors > Card Edge Connectors > PCI & PCI Express Connectors



Connector System: Board-to-Board

Number of Positions: 164

PCI Generation: 4

Centerline (Pitch): 1 mm [.039 in]

Contact Mating Area Plating Material Thickness: [15 µin]

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
Sealable	No

Configuration Features

Number of Positions	164
PCB Mount Orientation	Vertical
Ejector	Without

Body Features

Contact Features

Contact Current Rating (Max)	1.1 A
Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Gold (Au)
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin
	15 µin

Mechanical Attachment

Connector Mounting Type Board Mount	
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Housing Features	
Centerline (Pitch)	1 mm[.039 in]
Dimensions	
PCB Thickness (Accepted)	1.57 mm
Usage Conditions	
Operating Temperature Range	-40 - 85 °C[-40 - 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Bus Type	PCI Express
PCI Generation	4
Packaging Features	
Packaging Method	Box & Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought

















Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_4-2337939-8_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_4-2337939-8_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_4-2337939-8_A.3d_stp.zip

Board-to-Board, 164 Position, 1 mm [.039 in] Centerline, Vertical, Black, Signal, -40 – 85 °C [-40 – 185 °F], PCI & PCI Express Connectors



English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

AMP El Series, Connector

Japanese

Product Specification

Japanese

Product Specification

English

Agency Approvals

UL Report

English

UL Report

English